Unipolar Plasma Model of RF Breakdown

Z. Insepov, J. Norem

1) Purdue University, 2) Nanosynergy Inc





Outline

Motivation - RF breakdown in cavities Calculation of electric field for real surfaces **Experimental enhancement factor for dark current** Cluster field evaporation in high electric field Unipolar (Schwirzke) plasma model development Surface sputtering by ions Atomistic model of non-Debye plasma Plasma model of RF BD Conclusions

RF Breakdown examples

Severe damage

Moderate damage



[From the 2001 Report on the Next Linear Collider]

Calculation of electric field for real surfaces

FE multi-physics simulation

• Comsol simulation : Solving Laplace's equation for arbitrary geometry



Field Enhancement by tips

Comsol simulation vs analytical theory of field enhancement



Field Enhancement by cones



Surface: Electric field, norm [V/m] Contour: Electric potential [V] Max: 8.738e7 x10⁻⁵ ×10⁷ -1.206 -1.207 -1.208 -1.209 -1.21 -1.211 -1.212 -1.213 -1.214 0.5 0.6 1.1 1.2 1.3 0.7 0.8 0.9 1 1.4 1.5 Min: 3.631e4 ×10⁻⁷

-1.15 ×10⁻⁵ -1.16 -1.17 -1.18 -1.19 -1.2 -1.21 -1.22 -1.23 -1.24 -1.25 -1.26 -1.27 -1.28 -1.29 -1.3 -1.31 -1.32 -1.33 -1.34 -1.4 -1.2 -1 -0.8 -0.6 -0.4 -0.2 0 0.2 0.4 1.4 1.6 0.6 0.8 1.2 ×10⁻⁶



• Comsol simulation of field enhancement at sharp cones

Enhancement at crack's edges

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• Sharp tips, edges and corners of the cracks can significantly enhance the electric field



Comparison of FE for two cones: a sharp vs rounded cone



More exotic cracks can enhance the electric field too





Triple junction E-fields

We have been modeling, cracks, junctions, edges and other shapes
 Comsol simulation of field enhancement at triple crack junction







Experimental enhancement factor obtained from dark current measurements: β = 184

Comparison with experiment



Cluster field evaporation – a result of a high local electric field

Why atomistic simulation?



CLIC RF Breakdown Workshop, CERN 2008

Cluster field evaporation





Figure shows abrupt discontinuities in the voltage vs. number of ions in a DCfield evaporation system and evidence for large clusters produced at field ion microscope tips.

Electric field initiates breakdown

- Surfaces contain grain boundaries, tips, oxides, dust particles
- A strong electrostatic field enhancement can be generated
- Maxwell stress includes electric forces acting on the tip
- The chunks fill the near region of the vacuum
- Ionization by FN-electrons and Coulomb explosion form plasma
- Unipolar plasma model can explain triggering of the breakdown



Crater formation via field evaporation

 A new mechanism of crater formation – pulling out a large area of the surface



S. Yip, MIT 2014 (private communication)

Unipolar (Schwirzke) Plasma model development

Double electric layer in plasma



F. R. Schwirzke, IEEE Trans. on Plas. Sci., **19**, 690 (1991)



SEM image of plasma damaged metal surface: Superposition of "younger" (10 μ m) and "older" craters (30-40 μ m).

Unipolar arc breakdown model



BD triggered by impact ionization

- Neutrals accumulated in the dark space
- Ionization of neutrals by FN-current
- Percolation of dark space via ionization
- Crater formation via explosion

Unipolar Arc Model

$$V_{pl} = \frac{k_B T_e}{2e} \ln\left(\frac{M_i}{2\pi m_e}\right), \text{ Plasma potential}$$

$$E_s = \frac{V_{pl}}{\lambda_d}, \text{ Surface field}$$

$$\lambda_d = \left(\frac{\varepsilon_0 V_{pl}}{n_e e^2}\right)^{1/2} \text{ Debye length}$$

$$\phi \frac{V_{pl}}{V_{pl}} \frac{V_{pl}}{V_{pl}} \sim 100 \text{ V}$$

face field

ye length



Unipolar Arc model in linac



[•] Schwirzke model

Self-sputtering by plasma



Self-sputtering is the main mechanism of plasma fueling

Surface sputtering by ions

- Sigmund's theory linear cascades, not good for heavy ions and low energies
- Monte Carlo codes: binary collisions, not accurate at low energies
- Empirical models based on MC good for known materials
- Molecular dynamics time consuming but no limit for energies, ion masses, temperatures, dense cascades, thermal properties - can verify the OOPIC/VORPAL simulations

Sputtering theory and models

• Sigmund's theory

Eckstein-Bohdansky's model

 $Y(E) = \Lambda F_D(E),$ $\Lambda = \frac{3}{4\pi^2} \frac{1}{NC_0 U_s} = \frac{0.0420}{NU_s},$ $F_D(E) = \alpha (M_2/M_1) NS_n(E)$ $F_D(E) - \text{deposited energy},$ N - atomic density, $U_s - \text{surface binding energy},$ $S_n(E) - \text{nuclear stopping power},$

 C_0 – coefficient.

Not applicable for heavy ions C_0 , U_s - adjustable parameter.

$$Y(E) = Qs_n \left(\varepsilon \right) \left[1 - \left(\frac{E_{th}}{E} \right)^{2/3} \right] \left[1 - \left(\frac{E_{th}}{E} \right) \right]^2,$$

Q, E_{th} – adjustable parameters,

$$\varepsilon = E \frac{M_2}{M_1 + M_2} \frac{a_L}{Z_1 Z_2 e^2}, (\varepsilon \text{ - reduced energy})$$
$$a_L = 0.4685 \left\{ Z_1^{2/3} + Z_2^{2/3} \right\}^{-1/2} \text{A}$$
$$s_n^{TF}(\varepsilon) = \frac{3.441 \sqrt{\varepsilon} \ln(1 + 1.2288\varepsilon)}{\varepsilon + 0.1728 \sqrt{\varepsilon} + \varepsilon \left(6.882 \sqrt{\varepsilon} - 1.708\right)}.$$

Not applicable for light ion, high energy ions (no electronic stopping power). Needs adjustable parameters.

[Bohdansky, NIMB B (1984)]

Yamamura's empirical model

Yamamura's interpolation model based on Monte-Carlo code

$$Y(E) = 0.042 \frac{F_D(E)}{NU_s} \left[1 - \sqrt{\frac{E_{th}}{E}} \right] =$$

$$0.042 \frac{\alpha (M_2/M_1)S_n(E)}{NU_s} \left[1 - \sqrt{\frac{E_{th}}{E}} \right]$$

$$N - \text{atomic density}, U_s - \text{surface binding energy},$$

$$S_n(E) - \text{nuclear stopping power},$$

$$\alpha - \text{adjustable parameter},$$

$$Y(E) = 0.042 \frac{\alpha (M_2/M_1)}{U_s} \frac{S_n(E)s_n(\varepsilon)}{s_n(\varepsilon) + S_n(E)} \times \left[1 - \sqrt{\frac{E_{th}}{E}} \right]^s$$

$$E_{th} = \begin{cases} \frac{6.7}{\gamma}, & M_1 \ge M_2, \\ \frac{1 + 5.7(M_1/M_2)}{\gamma}, & M_1 \le M_2. \end{cases}$$

$$\gamma = \frac{4M_1M_2}{(M_1 + M_2)^2}.$$

No temperature dependence



FIG. 123 ENERGY DEPENDENCE OF THE SPUTTERING YIELD OF CU WITH CU*. A= 1.00,0= 1.00,Us= 3.49ev,s= 2.50, W= 0.21Us.

MD simulation of Copper self-sputtering at high T and E



- Self-sputtering is the mechanism for fueling unipolar surface plasma.
- Unipolar model requires Y > 10 typical at low ion energies.
- MD predicts very high sputtering yields for high surface *T* and *E*.
- Erosion rates on the order of ~ 1 m/s.

Atomistic model of non-Debye near-surface plasma

n-T Diagram for plasmas



Density-Temperature Diagram



Density-Temperature Diagram



Simulation Features

- Classical molecular dynamics (MD) simulations with a pseudopotential to account for quantum effects
- Two component plasma of electrons and copper ions
- Long range Coulomb interactions (*N*-body problem)
- Nearest image method (periodical boundary conditions) for the transversal dimensions
- Absorption of electrons to the surface with generation of the surface electrostatic field
- Simulation of the relaxation process
- Averaging over an ensemble of initial states

Interaction Potentials



Electron-ion interaction potential

$$U_{ei}(r) = -\frac{Ze^2}{r} \operatorname{erf}\left(\frac{r}{\sigma}\right)$$

Ionization potential for Copper $U_{min} = U_{ei}(0) = -7.73 \text{ eV}$ $(\sigma = 0.21 \text{ nm})$

Electron-electron and ion-ion potentials are pure Coulomb. The erf-like electron-ion interaction potential given above was used e.g. for simulations of sodium clusters in *T. Raitza, H. Reinholz, G. Röpke, I. Morozov, E. Suraud, Contrib. Plasma Phys* **49** 496 (2009).

Interaction Potentials



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Surface electric field in box

$$a = \frac{L_x}{2} = \frac{L_y}{2}$$

$$\sigma = \frac{q}{L_x L_y} \quad \text{(charge density)}$$
Electric potential on z axis
$$\phi(z) = -\frac{\sigma}{4\pi\varepsilon_0} \int_{-L_x/2}^{L_x/2} dx \int_{-L_y/2}^{L_y/2} dy \frac{1}{\sqrt{x^2 + y^2 + z^2}}$$

$$= -\frac{\sigma}{\pi\varepsilon_0} \left(z \arctan\left[\frac{a^2}{z\sqrt{2a^2 + z^2}}\right] + a \log\left[\frac{\sqrt{2a^2 + z^2} - a}{\sqrt{2a^2 + z^2} + a}\right] \right)$$

Longitudinal component of the electric field

$$E_{z}(z) = -\frac{\partial \phi}{\partial z} = \frac{\sigma}{\pi \varepsilon_{0}} \arctan\left[\frac{a^{2}}{z\sqrt{2a^{2}+z^{2}}}\right]$$



E-field and density vs time



Stationary plasma sheath



Effect of Interaction potential

The parameters used in this paper $U_{min} = -7.73 \text{ eV} (\sigma = 0.21 \text{ nm})$ Test potential: $U_{min} = -5.1 \text{ eV} (\sigma = 0.32 \text{ nm})$



Sheath for stationary state



Sheath for stationary state



Screening length vs density



Screening length vs density



Screening length vs G



E-field vs plasma density



Plasma model of RF breakdown



(1) Fowler-Nordheim equation for electrons (β = 100, 200)

(2) Langmuir-Child equation for ion current from plasma to the tip (*d*=1 μm)

(3) Richardson-Dushman equation for thermionic emission of electrons from liquid Cu (T=1300K)

(4) Sputtering Flux was calculated from Bohm current (plasma ion fluxes) times the sputtering yield at T=1300K

OOPIC Pro 2.5D modeling

Simulation showing how rf arcs start (805 MHz)



Summary of the Arc model



Tonks-Frenkel instability Capillary waves can measure surface fields

Dimensions of structures imply E_{surface} ~ 1 GV/m, if P_{surface tension} = P_{Electrostatic}.



Theory of Thonks instability

The dynamics of a non-equilibrium surface profile in contact with plasma can be determined from an surface dynamics (Kuramoto-Sivashinski) equation:

$$\frac{dh(r,t)}{dt} = \eta \nabla h(r,t) + \nu \Delta h(r,t) - k \nabla^4 h(r,t) + f_{MC}$$

Here, h – is the heights at a 2d-position r {x,y}, at time t.

The coefficients in this equation have the meanings: η – the viscosity coefficient, $\sqrt[]{}$ – the surface tension term, k - the diffusion coefficient, f_{MC} – the sputter by plasma ions.



Other applications of arcing

- We are beginning to develop parameter sets for these cases:
- Tokamak edge plasmas
- Large surface area and long DC pulses.
 This model predicts that breakdown will occur when the E_{local} >5 6 GV/m.
- $(\phi / \lambda_D) \beta \sim 6 \, \mathrm{GV}/\mathrm{m}$
- With a 100 eV sheath potential, and $\lambda_{\rm D}$ ~ 6 μ m gives,
 - eta~ (6 GV/m)(6E-6m)/(100 eV) ~ 400,
- Laser Ablation, micrometeorite impacts
- Tiny areas and very short DC pulses.
- Dense plasmas can appear and arcs must trigger more quickly.
 - With $\lambda_{\text{D}} \thicksim 0.1~\mu\text{m}$,
- $(\phi \lambda_{\rm D}) \beta \sim 11 \, {\rm GV/m},$
 - ϕ ~ (11 GV/m)(1E-7m)/30 ~ 40 eV
- These arcs would have similar parameters and would develop as described above

Conclusions

- Our picture of arcs is becoming simpler and more general.
- We find electrostatic fields can both trigger and drive arcs.
- Materials properties are the clue for understanding of unipolar arc formation and rf breakdown.
- We are exploring new mechanisms and news models, with a number of papers underway.